

# SN54ABT16460, SN74ABT16460 4-TO-1 MULTIPLEXED/DEMULTIPLEXED TRANSCEIVERS WITH 3-STATE OUTPUTS

SCBS207B – OCTOBER 1992 – REVISED JULY 1994

- Members of the Texas Instruments *Widebus™* Family
- State-of-the-Art *EPIC-II B™* BiCMOS Design Significantly Reduces Power Dissipation
- Latch-Up Performance Exceeds 500 mA Per JEDEC Standard JESD-17
- Typical  $V_{OLP}$  (Output Ground Bounce)  $< 1$  V at  $V_{CC} = 5$  V,  $T_A = 25^\circ\text{C}$
- Distributed  $V_{CC}$  and GND Pin Configuration Minimizes High-Speed Switching Noise
- Flow-Through Architecture Optimizes PCB Layout
- High-Drive Outputs ( $-32$ -mA  $I_{OH}$ ,  $64$ -mA  $I_{OL}$ )
- Bus-Hold Inputs Eliminate the Need for External Pullup Resistors
- Package Options Include Plastic 300-mil Shrink Small-Outline (DL) Package and 380-mil Fine-Pitch Ceramic Flat (WD) Package Using 25-mil Center-to-Center Spacings

SN54ABT16460 . . . WD PACKAGE  
SN74ABT16460 . . . DL PACKAGE  
(TOP VIEW)

LEAB1	1	56	$\overline{\text{OEB1}}$
LEAB2	2	55	$\overline{\text{OEB2}}$
LEBA	3	54	SEL0
GND	4	53	GND
LEB1	5	52	1B1
LEB2	6	51	1B2
$V_{CC}$	7	50	$V_{CC}$
CLKBA	8	49	1B3
$\overline{\text{OEB}}$	9	48	1B4
CLKAB	10	47	2B1
GND	11	46	GND
1A	12	45	2B2
2A	13	44	2B3
CE_SEL0	14	43	2B4
CE_SEL1	15	42	3B1
3A	16	41	3B2
4A	17	40	3B3
GND	18	39	GND
CLKENAB	19	38	3B4
$\overline{\text{CLKENB}}$	20	37	4B1
CLKENBA	21	36	4B2
$V_{CC}$	22	35	$V_{CC}$
LEB3	23	34	4B3
LEB4	24	33	4B4
GND	25	32	GND
$\overline{\text{OEA}}$	26	31	SEL1
LEAB3	27	30	$\overline{\text{OEB3}}$
LEAB4	28	29	$\overline{\text{OEB4}}$

## description

The 'ABT16460 are 4-bit-to-1-bit multiplexed registered transceivers used in applications where four separate data paths must be multiplexed onto or demultiplexed from a single data path. Typical applications include multiplexing and/or demultiplexing of address and data information in microprocessor- or bus-interface applications. These devices are also useful in memory-interleaving applications.

Five 4-bit I/O ports (1A–4A, 1B1–4, 2B1–4, 3B1–4, and 4B1–4) are available for address and/or data transfer. The output-enable ( $\overline{\text{OEB}}$ ,  $\overline{\text{OEB1}}$ – $\overline{\text{OEB4}}$ , and  $\overline{\text{OEA}}$ ) inputs control the bus-transceiver functions. These control signals also allow 4-bit or 16-bit control depending on the  $\overline{\text{OEB}}$  level.

Address and/or data information can be stored using the internal storage latches/flip-flops. The latch-enable (LEB1–LEB4, LEBA, and LEAB1–LEAB4) and clock/clock-enable (CLK/CLKEN) inputs are used to control data storage. When either one of the latch-enable inputs is high, the latch is transparent (clock is a don't care as long as the latch-enable is high). When the latch-enable input goes low (providing that the clock does not transit from low to high), the data present at the inputs is latched and remains latched until the latch-enable input is returned high. When the clock-enable is low and the corresponding latch-enable is low, data can be clocked on the low to high transition of the clock. When either the clock-enable or the corresponding latch-enable is high, the clock is a don't care.

Four select pins (SEL0, SEL1, CE\_SEL0, and CE\_SEL1) are provided to multiplex data (A port), or to select one of four clock-enables (B port). This allows the user to have the flexibility of controlling one bit at a time.

Active bus-hold circuitry is provided to hold unused or floating inputs at a valid logic level.

Widebus and EPIC-II B are trademarks of Texas Instruments Incorporated.

UNLESS OTHERWISE NOTED this document contains PRODUCTION DATA information current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

 **TEXAS  
INSTRUMENTS**

POST OFFICE BOX 655303 • DALLAS, TEXAS 75265

Copyright © 1994, Texas Instruments Incorporated

# SN54ABT16460, SN74ABT16460

## 4-TO-1 MULTIPLEXED/DEMULTIPLEXED TRANSCEIVERS

### WITH 3-STATE OUTPUTS

SCBS207B – OCTOBER 1992 – REVISED JULY 1994

#### description (continued)

To ensure the high-impedance state during power-up or power-down,  $\overline{OE}$  should be tied to  $V_{CC}$  through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

The SN74ABT16460 is available in TI's shrink small-outline package (DL), which provides twice the I/O pin count and functionality of standard small-outline packages in the same printed-circuit-board area.

The SN54ABT16460 is characterized for operation over the full military temperature range of  $-55^{\circ}\text{C}$  to  $125^{\circ}\text{C}$ . The SN74ABT16460 is characterized for operation from  $-40^{\circ}\text{C}$  to  $85^{\circ}\text{C}$ .

#### Function Tables

A-TO-B OUTPUT ENABLE†

INPUTS		OUTPUT B <sub>n</sub>
$\overline{OEB}$	$\overline{OEB}_n$	
H	H	Z
H	L	Z
L	H	Z
L	L	Active

† n = 1, 2, 3, 4

A-TO-B STORAGE  
(assuming  $\overline{OEB} = \text{L}$ ,  $\overline{OEB}_n = \text{L}$ )‡

INPUTS								OUTPUTS			
$\overline{\text{CLKENAB}}$	CE_SEL1	CE_SEL0	CLKAB	LEAB1	LEAB2	LEAB3	LEAB4	B1	B2	B3	B4
X	X	X	H or L	H	L	L	L	A	A <sub>0</sub>	A <sub>0</sub>	A <sub>0</sub>
X	X	X	H or L	H	H	H	L	A	A	A	A <sub>0</sub>
L	X	X	L	L	L	L	L	A <sub>0</sub>	A <sub>0</sub>	A <sub>0</sub>	A <sub>0</sub>
L	L	L	↑	L	L	L	L	A	A <sub>0</sub>	A <sub>0</sub>	A <sub>0</sub>
L	L	H	↑	L	L	L	L	A <sub>0</sub>	A	A <sub>0</sub>	A <sub>0</sub>
L	H	L	↑	L	L	L	L	A <sub>0</sub>	A <sub>0</sub>	A	A <sub>0</sub>
L	H	H	↑	L	L	L	L	A <sub>0</sub>	A <sub>0</sub>	A <sub>0</sub>	A
H	X	X	↑	L	L	L	L	A <sub>0</sub>	A <sub>0</sub>	A <sub>0</sub>	A <sub>0</sub>

‡ This table does not cover all the latch-enable cases since they have similar results.

SN54ABT16460, SN74ABT16460  
4-TO-1 MULTIPLEXED/DEMULTIPLEXED TRANSCEIVERS  
WITH 3-STATE OUTPUTS

SCBS207B – OCTOBER 1992 – REVISED JULY 1994

**Function Tables (Continued)**

**B-TO-A STORAGE  
(before point P)**

INPUTS								P
CLKENB	CLKBA	LEB1	LEB2	LEB3	LEB4	SEL1	SEL0	
X	X	H	L	L	L	L	L	B1
X	X	L	H	L	L	L	H	B2
X	X	L	L	H	L	H	L	B3
X	X	L	L	L	H	H	H	B4
L            ↑            L            L            L            L						L	L	B1
						L	H	B2
						H	L	B3
						H	H	B4
L            L            L            L            L            L						L	L	B1 <sup>†</sup>
						L	H	B2 <sup>†</sup>
						H	L	B3 <sup>†</sup>
						H	H	B4 <sup>†</sup>

† Output level before the indicated steady-state input conditions were established.

**B-TO-A STORAGE  
(after point P)**

INPUTS					OUTPUT A
CLKENB <sup>A</sup>	CLKBA	LEBA	$\overline{OE}A$	B	
X	X	X	H	X	Z
X	X	H	L	L	L
X	X	H	L	H	H
H	X	L	L	X	A <sub>0</sub> <sup>†</sup>
L	↑	L	L	L	L
L	↑	L	L	H	H
L	L	L	L	X	A <sub>0</sub> <sup>†</sup>

† Output level before the indicated steady-state input conditions were established.

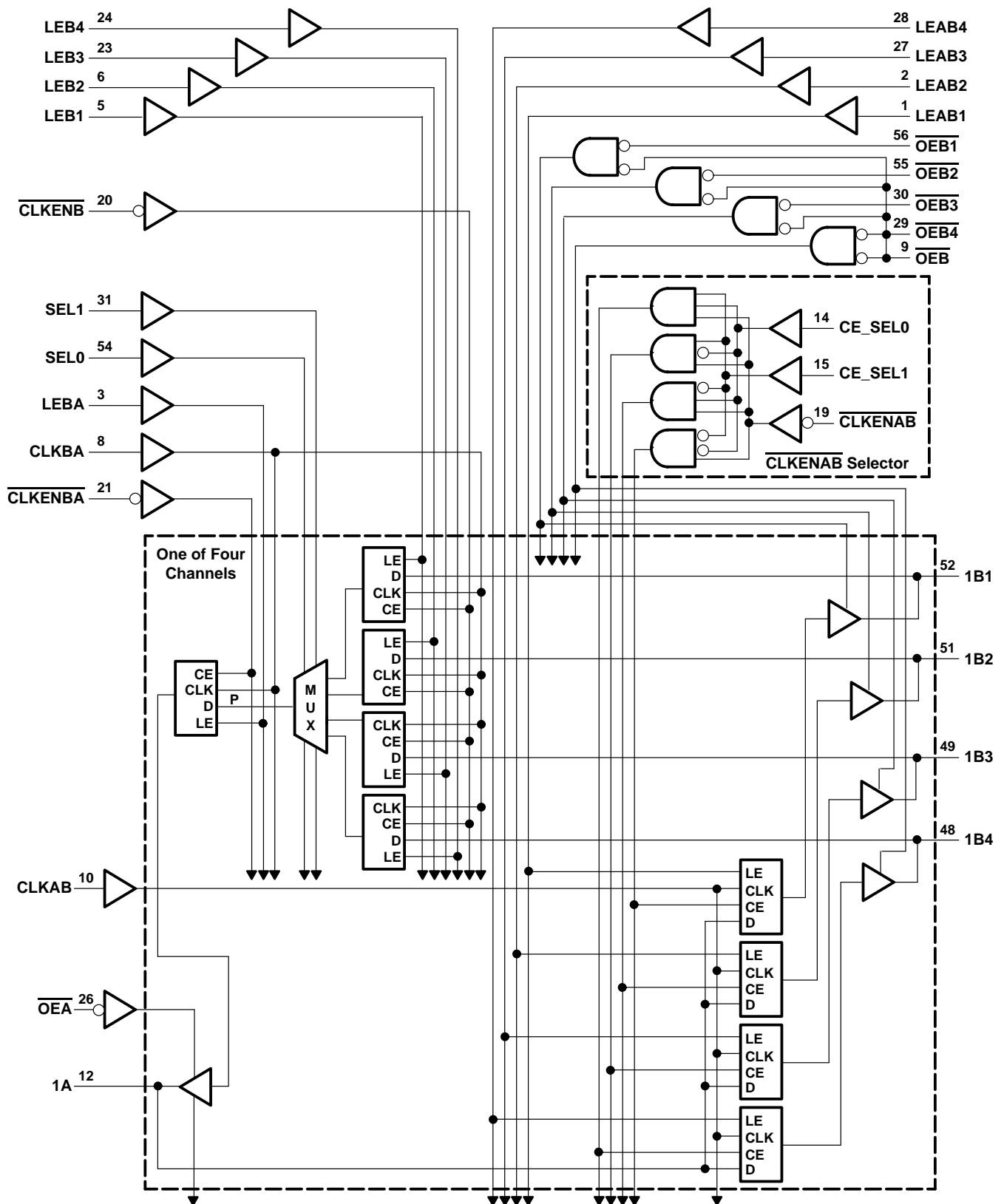
# SN54ABT16460, SN74ABT16460

## 4-TO-1 MULTIPLEXED/DEMULTIPLEXED TRANSCEIVERS

### WITH 3-STATE OUTPUTS

SCBS207B – OCTOBER 1992 – REVISED JULY 1994

#### logic diagram (positive logic)



# SN54ABT16460, SN74ABT16460

## 4-TO-1 MULTIPLEXED/DEMULTIPLEXED TRANSCEIVERS WITH 3-STATE OUTPUTS

SCBS207B – OCTOBER 1992 – REVISED JULY 1994

### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, $V_{CC}$	–0.5 V to 7 V
Input voltage range, $V_I$ (except I/O ports) (see Note 1)	–0.5 V to 7 V
Voltage range applied to any output in the high state or power-off state, $V_O$	–0.5 V to 5.5 V
Current into any output in the low state, $I_O$ : SN54ABT16460	96 mA
SN74ABT16460	128 mA
Input clamp current, $I_{IK}$ ( $V_I < 0$ )	–18 mA
Output clamp current, $I_{OK}$ ( $V_O < 0$ )	–50 mA
Maximum power dissipation at $T_A = 55^\circ\text{C}$ (in still air) (see Note 2): DL package	1.4 W
Storage temperature range	–65°C to 150°C

† Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.  
 2. The maximum package power dissipation is calculated using a junction temperature of 150°C and a board trace length of 750 mils.  
 For more information, refer to the *Package Thermal Considerations* application note in the 1994 *ABT Advanced BiCMOS Technology Data Book*, literature number SCBD002B.

### recommended operating conditions (see Note 3)

		SN54ABT16460		SN74ABT16460		UNIT
		MIN	MAX	MIN	MAX	
$V_{CC}$	Supply voltage	4.5	5.5	4.5	5.5	V
$V_{IH}$	High-level input voltage	2		2		V
$V_{IL}$	Low-level input voltage		0.8		0.8	V
$V_I$	Input voltage	0	$V_{CC}$	0	$V_{CC}$	V
$I_{OH}$	High-level output current		–24		–32	mA
$I_{OL}$	Low-level output current		48		64	mA
$\Delta t/\Delta v$	Input transition rise or fall rate	Outputs enabled		10		ns/V
$\Delta t/\Delta V_{CC}$	Power-up ramp rate					μs/V
$T_A$	Operating free-air temperature	–55	125	–40	85	°C

NOTE 3: Unused or floating pins (input or I/O) must be held high or low.

# SN54ABT16460, SN74ABT16460

## 4-TO-1 MULTIPLEXED/DEMULTIPLEXED TRANSCEIVERS

### WITH 3-STATE OUTPUTS

SCBS207B – OCTOBER 1992 – REVISED JULY 1994

**electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)**

PARAMETER		TEST CONDITIONS		T <sub>A</sub> = 25°C			SN54ABT16460		SN74ABT16460		UNIT	
				MIN	TYP†	MAX	MIN	MAX	MIN	MAX		
V <sub>IK</sub>		V <sub>CC</sub> = 4.5 V, I <sub>I</sub> = -18 mA		-1.2			-1.2		-1.2		V	
V <sub>OH</sub>		V <sub>CC</sub> = 4.5 V, I <sub>OH</sub> = -3 mA		2.5			2.5		2.5		V	
		V <sub>CC</sub> = 5 V, I <sub>OH</sub> = -3 mA		3			3		3			
		V <sub>CC</sub> = 4.5 V	I <sub>OH</sub> = -24 mA	2			2					
			I <sub>OH</sub> = -32 mA	2*					2			
V <sub>OL</sub>		V <sub>CC</sub> = 4.5 V	I <sub>OL</sub> = 48 mA	0.36			0.5				V	
			I <sub>OL</sub> = 64 mA	0.55*					0.55			
I <sub>I</sub>	Control inputs	V <sub>CC</sub> = 0 to 5.5 V, V <sub>I</sub> = V <sub>CC</sub> or GND		±1			±1		±1		μA	
	A or B ports	V <sub>CC</sub> = 2.1 V to 5.5 V, V <sub>I</sub> = V <sub>CC</sub> or GND		±20			±20		±20			
I <sub>I</sub> (hold)	A or B ports	V <sub>CC</sub> = 4.5 V	V <sub>I</sub> = 0.8 V	75	500	75	500	75	500	75	500	μA
			V <sub>I</sub> = 2 V	-75	-500	-75	-500	-75	-500	-75	-500	
I <sub>OZPU</sub> ‡		V <sub>CC</sub> = 0 to 2.1 V, V <sub>O</sub> = 0.5 to 2.7 V, $\overline{OE}$ = X		±50			±50		±50		μA	
I <sub>OZPD</sub> ‡		V <sub>CC</sub> = 2.1 V to 0, V <sub>O</sub> = 0.5 to 2.7 V, $\overline{OE}$ = X		±50			±50		±50		μA	
I <sub>OZH</sub> §		V <sub>CC</sub> = 2.1 V to 5.5 V, V <sub>O</sub> = 2.7 V, $\overline{OE} \geq 2$ V		10			10		10		μA	
I <sub>OZL</sub> §		V <sub>CC</sub> = 2.1 V to 5.5 V, V <sub>O</sub> = 0.5 V, $\overline{OE} \geq 2$ V		-10			-10		-10		μA	
I <sub>off</sub>		V <sub>CC</sub> = 0, V <sub>I</sub> or V <sub>O</sub> ≤ 4.5 V		±100					±100		μA	
I <sub>CEX</sub>	Outputs high	V <sub>CC</sub> = 5.5 V, V <sub>O</sub> = 5.5 V		50			50		50		μA	
I <sub>O</sub> ¶		V <sub>CC</sub> = 5.5 V, V <sub>O</sub> = 2.5 V		-50	-100	-200	-50	-200	-50	-200	mA	
I <sub>CC</sub>	Outputs high	V <sub>CC</sub> = 5.5 V, I <sub>O</sub> = 0, V <sub>I</sub> = V <sub>CC</sub> or GND		1.5			1.5		1.5		mA	
	A outputs low			10			10		10			
	B outputs low			32			32		32			
	Outputs disabled			1.5			1.5		1.5			
ΔI <sub>CC</sub> #		V <sub>CC</sub> = 5.5 V, One input at 3.4 V, Other inputs at V <sub>CC</sub> or GND		1.5			1.5		1.5		mA	
C <sub>i</sub>	Control inputs	V <sub>I</sub> = 2.5 V or 0.5 V		8							pF	
C <sub>io</sub>	A or B ports	V <sub>O</sub> = 2.5 V or 0.5 V		3.5							pF	

\* On products compliant to MIL-STD-883, Class B, this parameter does not apply.

† All typical values are at V<sub>CC</sub> = 5 V.

‡ This parameter is characterized but not tested.

§ The parameters I<sub>OZH</sub> and I<sub>OZL</sub> include the input leakage current.

¶ Not more than one output should be tested at a time, and the duration of the test should not exceed one second.

# This is the increase in supply current for each input that is at the specified TTL voltage level rather than V<sub>CC</sub> or GND.

# SN54ABT16460, SN74ABT16460

## 4-TO-1 MULTIPLEXED/DEMULTIPLEXED TRANSCEIVERS

### WITH 3-STATE OUTPUTS

SCBS207B – OCTOBER 1992 – REVISED JULY 1994

**timing requirements over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)**

			SN54ABT16460		SN74ABT16460		UNIT
			MIN	MAX	MIN	MAX	
$f_{\text{clock}}$	Clock frequency		0	160	0	160	MHz
$t_w$	Pulse duration	CLKAB high or low	3.8		3.8		ns
		CLKBA high or low	4.5		4.5		
		LEAB1, 2, 3, or 4 high	2.2		2.2		
		LEBA high	2.1		2.1		
		LEB1, 2, 3, or 4 high	2.4		2.4		
$t_{\text{su}}$	Setup time	Before CLKAB $\uparrow$	A bus	2.5	2.5		ns
			CE_SEL0/1	3.2	3.2		
			CLKENAB	3.2	3.2		
		Before LEAB1, 2, 3, or 4 $\downarrow$	A bus	3.6	3.6		
			B bus	3.8	3.8		
			CLKENB	2.3	2.3		
		Before CLKBA $\uparrow$	CLKENBA	2.5	2.5		
			LEB1, 2, 3, or 4	4.3	4.3		
			SEL0/1	4.5	4.5		
		Before LEB1, 2, 3, or 4 $\downarrow$	B bus	3.2	3.2		
		Before LEBA $\downarrow$	B bus	4	4		
			LEB1, 2, 3, or 4	4.4	4.4		
			SEL0/1	4.3	4.3		
$t_h$	Hold time	After CLKAB $\uparrow$	A bus	0.5	0.5		ns
			CE_SEL0/1	1.1	1.1		
			CLKENAB	0.5	0.5		
		After LEAB1, 2, 3, or 4 $\downarrow$	A bus	1.2	1.2		
			B bus	1.3	1.3		
			CLKENB	1	1		
		After CLKBA $\uparrow$	CLKENBA	1	1		
			SEL0/1	0	0		
		After LEB1, 2, 3, or 4 $\downarrow$	B bus	1.5	1.5		
		After LEBA $\downarrow$	B bus	0.4	0.4		
			SEL0/1	0.1	0.1		

PRODUCT PREVIEW information concerns products in the formative or design phase of development. Characteristic data and other specifications are design goals. Texas Instruments reserves the right to change or discontinue these products without notice.



POST OFFICE BOX 655303 • DALLAS, TEXAS 75265

# SN54ABT16460, SN74ABT16460

## 4-TO-1 MULTIPLEXED/DEMULTIPLEXED TRANSCEIVERS

### WITH 3-STATE OUTPUTS

SCBS207B – OCTOBER 1992 – REVISED JULY 1994

switching characteristics over recommended ranges of supply voltage and operating free-air temperature,  $C_L = 50$  pF (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	$V_{CC} = 5$ V, $T_A = 25^\circ\text{C}$			SN54ABT16460		SN74ABT16460		UNIT
			MIN	TYP	MAX	MIN	MAX	MIN	MAX	
$f_{\max}$			160			160		160		MHz
$t_{PLH}$	B	A	2.5	3.6	5.9	2.5	7.1	2.5	6.5	ns
$t_{PHL}$			2	3.5	5.8	2	6.8	2	6.5	
$t_{PZH}$	$\overline{OEA}$	A	1.5	2.8	4.8	1.5	5.9	1.5	5.6	ns
$t_{PZL}$			1.5	2.6	4.6	1.5	5.5	1.5	5.2	
$t_{PHZ}$	$\overline{OEA}$	A	2.5	3.8	5.3	2.5	6	2.5	5.9	ns
$t_{PLZ}$			1.5	4.6	6.1	1.5	7	1.5	6.5	
$t_{PLH}$	A	B	2	3.2	5.2	2	6.2	2	5.7	ns
$t_{PHL}$			1.5	3.1	5.2	1.5	6.1	1.5	5.7	
$t_{PZH}$	$\overline{OEB}$	B	1.5	3.3	5.7	1.5	6.7	1.5	6.4	ns
$t_{PZL}$			1.5	3.2	5.5	1.5	6.6	1.5	6.3	
$t_{PHZ}$	$\overline{OEB}$	B	3	4.7	6.3	3	7.1	3	7	ns
$t_{PLZ}$			2	4	5.5	2	6.6	2	6.1	
$t_{PZH}$	$\overline{OEB1}, \overline{2}, \overline{3}, \overline{4}$	B	1.5	3	5.2	1.5	6	1.5	5.8	ns
$t_{PZL}$			1.5	2.9	4.9	1.5	5.9	1.5	5.6	
$t_{PHZ}$	$\overline{OEB1}, \overline{2}, \overline{3}, \overline{4}$	B	2.5	4	5.7	2.5	6.2	2.5	6.1	ns
$t_{PLZ}$			1.5	3.5	4.8	1.5	5.8	1.5	5.3	
$t_{PLH}$	CLKBA	A	1.5	4.2	6.7	1.5	8.1	1.5	7.4	ns
$t_{PHL}$			1.5	4.4	6.9	1.5	8.4	1.5	7.7	
$t_{PLH}$	CLKAB	B	2	3.4	5.6	2	6.8	2	6.2	ns
$t_{PHL}$			2	3.4	5.3	2	6.3	2	5.9	
$t_{PLH}$	LEBA	A	2	3	5	2	6.1	2	5.6	ns
$t_{PHL}$			2	3.1	4.8	2	5.8	2	5.3	
$t_{PLH}$	LEAB1, 2, 3, 4	B	2	3.2	5.2	2	6.3	2	5.8	ns
$t_{PHL}$			2	3.3	5	2	6.1	2	5.6	
$t_{PLH}$	LEBA1, 2, 3, 4	A	2.5	4	6.5	2.5	7.8	2.5	7.2	ns
$t_{PHL}$			2.5	4	6.1	2.5	7.5	2.5	6.8	
$t_{PLH}$	SEL	A	2	4.1	6.7	2	8.1	2	7.5	ns
$t_{PHL}$			2	3.8	6.2	2	7.3	2	6.9	

PRODUCT PREVIEW information concerns products in the formative or design phase of development. Characteristic data and other specifications are design goals. Texas Instruments reserves the right to change or discontinue these products without notice.

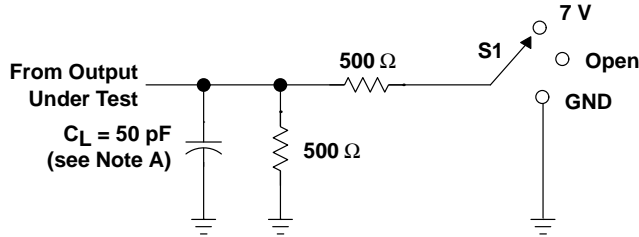




# SN54ABT16460, SN74ABT16460 4-TO-1 MULTIPLEXED/DEMULTIPLEXED TRANSCEIVERS WITH 3-STATE OUTPUTS

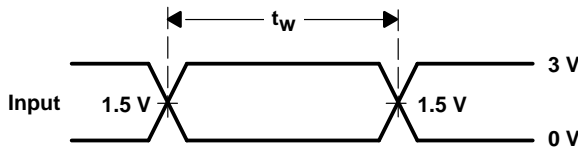
SCBS207B – OCTOBER 1992 – REVISED JULY 1994

## PARAMETER MEASUREMENT INFORMATION

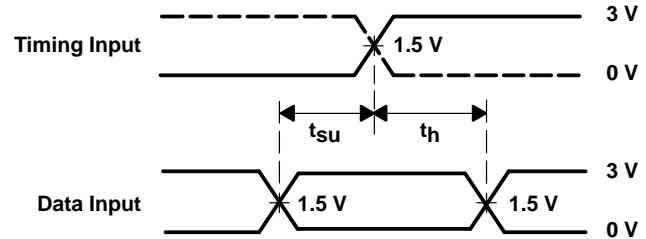


TEST	S1
$t_{PLH}/t_{PHL}$	Open
$t_{PLZ}/t_{PZL}$	7 V
$t_{PHZ}/t_{PZH}$	Open

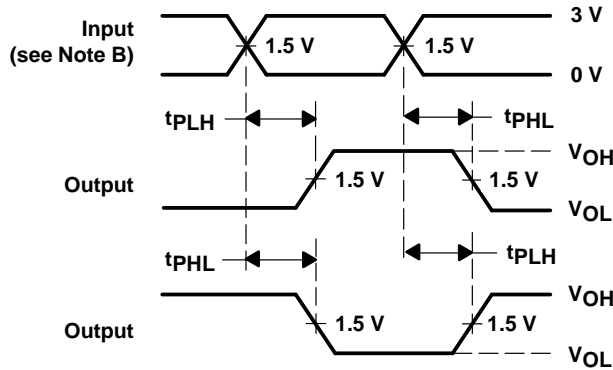
LOAD CIRCUIT FOR OUTPUTS



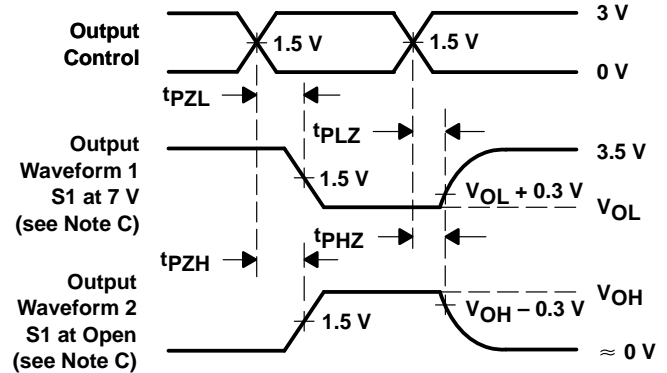
VOLTAGE WAVEFORMS  
PULSE DURATION



VOLTAGE WAVEFORMS  
SETUP AND HOLD TIMES



VOLTAGE WAVEFORMS  
PROPAGATION DELAY TIMES  
INVERTING AND NONINVERTING OUTPUTS



VOLTAGE WAVEFORMS  
ENABLE AND DISABLE TIMES  
LOW- AND HIGH-LEVEL ENABLING

- NOTES:
- $C_L$  includes probe and jig capacitance.
  - All input pulses are supplied by generators having the following characteristics:  $PRR \leq 10 \text{ MHz}$ ,  $Z_O = 50 \Omega$ ,  $t_r \leq 2.5 \text{ ns}$ ,  $t_f \leq 2.5 \text{ ns}$ .
  - Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
  - The outputs are measured one at a time with one transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms



## **IMPORTANT NOTICE**

Texas Instruments (TI) reserves the right to make changes to its products or to discontinue any semiconductor product or service without notice, and advises its customers to obtain the latest version of relevant information to verify, before placing orders, that the information being relied on is current.

TI warrants performance of its semiconductor products and related software to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are utilized to the extent TI deems necessary to support this warranty. Specific testing of all parameters of each device is not necessarily performed, except those mandated by government requirements.

Certain applications using semiconductor products may involve potential risks of death, personal injury, or severe property or environmental damage ("Critical Applications").

**TI SEMICONDUCTOR PRODUCTS ARE NOT DESIGNED, INTENDED, AUTHORIZED, OR WARRANTED TO BE SUITABLE FOR USE IN LIFE-SUPPORT APPLICATIONS, DEVICES OR SYSTEMS OR OTHER CRITICAL APPLICATIONS.**

Inclusion of TI products in such applications is understood to be fully at the risk of the customer. Use of TI products in such applications requires the written approval of an appropriate TI officer. Questions concerning potential risk applications should be directed to TI through a local SC sales office.

In order to minimize risks associated with the customer's applications, adequate design and operating safeguards should be provided by the customer to minimize inherent or procedural hazards.

TI assumes no liability for applications assistance, customer product design, software performance, or infringement of patents or services described herein. Nor does TI warrant or represent that any license, either express or implied, is granted under any patent right, copyright, mask work right, or other intellectual property right of TI covering or relating to any combination, machine, or process in which such semiconductor products or services might be or are used.